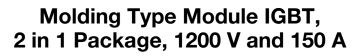
VS-GB150TH120U

Vishay Semiconductors

ROHS COMPLIANT





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| PRIMARY CHARACTERISTICS | | | | | |
|---|-----------------|--|--|--|--|
| V _{CES} 1200 V | | | | | |
| I _C at T _C = 80 °C | 150 A | | | | |
| $V_{CE(on)}$ (typical) at I _C = 150 A, T _J = 25 °C | 3.10 V | | | | |
| Speed | 8 kHz to 30 kHz | | | | |
| Package | Dual INT-A-PAK | | | | |
| Circuit configuration | Half bridge | | | | |

FEATURES

- 10 µs short circuit capability
- Low switching losses
- · Rugged with ultrafast performance
- V_{CE(on)} with positive temperature coefficient
- · Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- Inductive heating
- Electronic welder
- · Switching mode power supplies

DESCRIPTION

Vishay's IGBT power module provides ultrafast switching speed as well as short circuit ruggedness. It is designed for applications such as electronic welder and inductive heating.

| ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$ unless otherwise noted) | | | | | |
|---|--------------------------------|-------------------------|------|-------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS | |
| Collector to emitter voltage | V _{CES} | | 1200 | V | |
| Gate to emitter voltage | V _{GES} | | ± 20 | v | |
| Collector current | 1 | T _C = 25 °C | 219 | | |
| | I _C | T _C = 75 °C | 150 | | |
| Pulsed collector current | I _{CM} ⁽¹⁾ | t _p = 1 ms | 300 | А | |
| Diode continuous forward current | I _F | T _C = 80 °C | 150 | | |
| Diode maximum forward current | I _{FM} ⁽¹⁾ | t _p = 1 ms | 300 | | |
| Maximum power dissipation | PD | T _J = 150 °C | 1157 | W | |
| Short circuit withstand time | T _{SC} | T _J = 125 °C | 10 | μs | |
| RMS isolation voltage | VISOL | f = 50 Hz, t = 1 min | 2500 | V | |

Note

⁽¹⁾ Repetitive rating: pulse width limited by maximum junction temperature

| IGBT ELECTRICAL SPECIFICATIONS ($T_c = 25 \text{ °C}$ unless otherwise noted) | | | | | | |
|---|----------------------|--|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Collector to emitter breakdown voltage | V _{(BR)CES} | T _J = 25 °C | 1200 | - | - | |
| Collector to emitter saturation voltage | V | V_{GE} = 15 V, I _C = 150 A, T _J = 25 °C | - | 3.00 | 3.45 | v |
| | V _{CE(sat)} | $V_{GE} = 15 \text{ V}, \text{ I}_{C} = 150 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ | - | 3.80 | - | |
| Gate to emitter threshold voltage | V _{GE(th)} | V_{CE} = V_{GE} , I_C = 6.0 mA, T_J = 25 °C | 4.5 | 5.4 | 6.5 | |
| Collector cut-off current | I _{CES} | $V_{CE} = V_{CES}, V_{GE} = 0 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$ | - | - | 5.0 | mA |
| Gate to emitter leakage current | I _{GES} | $V_{GE} = V_{GES}, V_{CE} = 0 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$ | - | - | 400 | nA |

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| SWITCHING CHARACTERISTICS | 5 | | | | | |
|--|----------------------|--|------|------|------|----------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Turn-on delay time | t _{d(on)} | | - | 71 | - | |
| Rise time | t _r | | - | 52 | - | ns mJ |
| Turn-off delay time | t _{d(off)} | V _{CC} = 600 V, I _C = 150 A, R _g = 6.8 Ω, | - | 429 | - | |
| Fall time | t _f | $V_{GE} = \pm 15 \text{ V}, \text{ T}_{J} = 25 \text{ °C}$ | - | 116 | - | |
| Turn-on switching loss | E _{on} | | - | 9.2 | - | |
| Turn-off switching loss | E _{off} | | - | 7.0 | - | |
| Turn-on delay time | t _{d(on)} | | - | 71 | - | |
| Rise time | t _r | | - | 54 | - | ns |
| Turn-off delay time | t _{d(off)} | $V_{CC} = 600 \text{ V}, \text{ I}_{C} = 150 \text{ A}, \text{ R}_{g} = 6.8 \Omega,$ | - | 456 | - | |
| Fall time | t _f | | - | 134 | - | |
| Turn-on switching loss | E _{on} | | - | 13.2 | - | |
| Turn-off switching loss | E _{off} | | - | 8.3 | - | mJ |
| Input capacitance | Cies | | - | 11.0 | - | |
| Output capacitance | C _{oes} | V _{GE} = 0 V, V _{CE} = 30 V, f = 1.0 MHz | - | 1.14 | - | nF |
| Reverse transfer capacitance | C _{res} | | - | 0.50 | - | |
| SC data | I _{SC} | $\begin{array}{l} t_p \leq 10 \; \mu s, V_{GE} = 15 \; V, T_J = 125 \; ^{\circ}C, \\ V_{CC} = 900 \; V, V_{CEM} \leq 1200 \; V \end{array}$ | - | 950 | - | А |
| Internal gate resistance | Rg | | - | 1.3 | - | Ω |
| Stray inductance | L _{CE} | | - | - | 30 | nH |
| Module lead resistance, terminal to chip | R _{CC'+EE'} | T _C = 25 °C | - | 0.35 | - | mΩ |

| DIODE ELECTRICAL SPECIFICATIONS ($T_c = 25$ °C unless otherwise noted) | | | | | | | |
|--|------------------|---|-------------------------|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNITS |
| Forward voltage | V _F | I _F = 150 A, V _{GE} = 0 V | T _J = 25 °C | - | 1.80 | 2.25 | - V |
| Forward voltage | | | T _J = 125 °C | - | 1.75 | - | |
| Reverse recovery charge | Q _{rr} | | T _J = 25 °C | - | 9.1 | - | μC |
| | | | T _J = 125 °C | - | 20.0 | - | |
| | | $I_{rr} \qquad I_F = 150 \text{ A}, \text{ V}_R = 600 \text{ V}, \\ dI_F/dt = -2000 \text{ A}/\mu \text{s} \\ V_{GF} = -15 \text{ V}$ | T _J = 25 °C | - | 153 | - | ٨ |
| Peak reverse recovery current | Irr | | T _J = 125 °C | - | 191 | - | A |
| Reverse recovery energy | E _{rec} | | T _J = 25 °C | - | 3.2 | - | |
| | | | T _J = 125 °C | - | 7.5 | - | mJ |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | | | | |
|---------------------------------------|---------|------------------|--------------------------|------|-------|-------|-------|--|
| PARAMETER | | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Maximum junction temperature |) | TJ | | - | - | 150 | | |
| Operating junction temperature | e range | TJ | | -40 | - | 125 | °C | |
| Storage temperature range | | T _{STG} | | -40 | - | 125 | 1 | |
| Junction to case | IGBT | $R_{	hetaJC}$ | | - | - | 0.108 | | |
| | Diode | | | - | - | 0.200 | | |
| | IGBT | | | - | 0.031 | - | K/W | |
| Case to heatsink | Diode | $R_{\theta CS}$ | | - | 0.057 | - | | |
| | Module | | | - | 0.010 | - | | |
| Mounting to you o | | | Power terminal screw: M5 | 2.5 | - | 5.0 | Nm | |
| Mounting torque | | | Mounting screw: M6 | 3.0 | - | 5.0 | | |
| Weight | | | Weight of module | - | 300 | - | g | |

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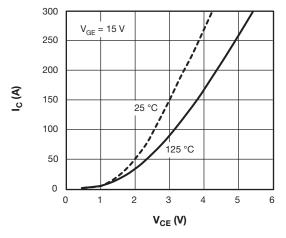


Fig. 1 - IGBT Typical Output Characteristics

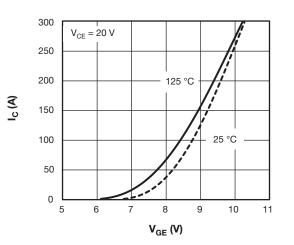
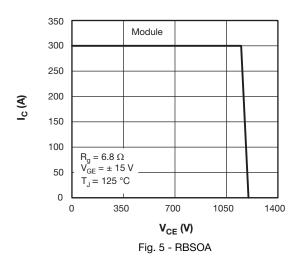
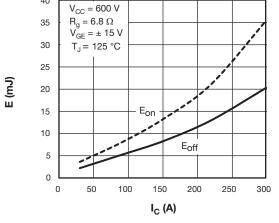


Fig. 2 - IGBT Typical Transfer Characteristics





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Fig. 3 - IGBT Switching Loss vs. I_C

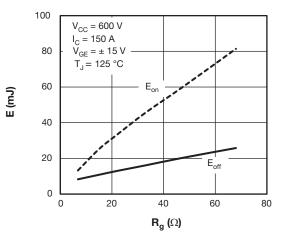


Fig. 4 - IGBT Switching Loss vs. R_q

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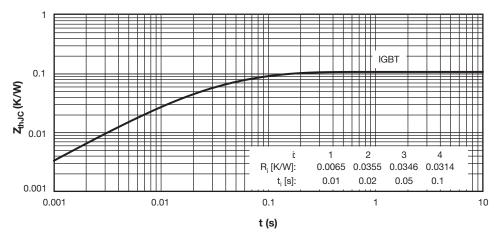
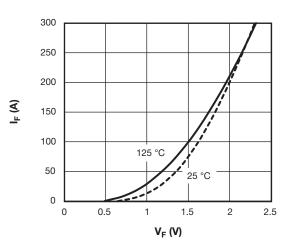


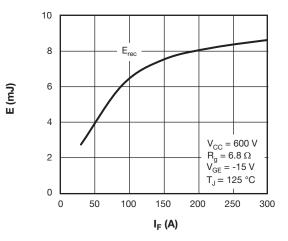
Fig. 6 - IGBT Transient Thermal Impedance



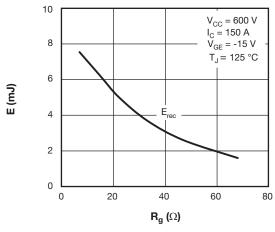
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Fig. 7 - Diode Typical Forward Characteristics





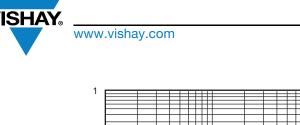




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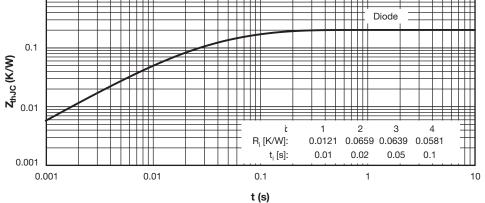
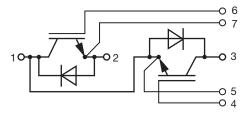


Fig. 10 - Diode Transient Thermal Impedance

CIRCUIT CONFIGURATION



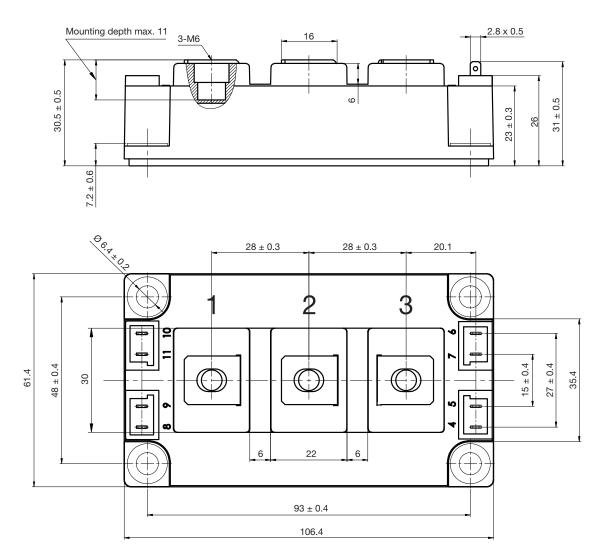
| LINKS TO RELATED DOCUMENTS | | | |
|----------------------------|--------------------------|--|--|
| Dimensions | www.vishay.com/doc?95525 | | |



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Double INT-A-PAK

DIMENSIONS in millimeters (inches)





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